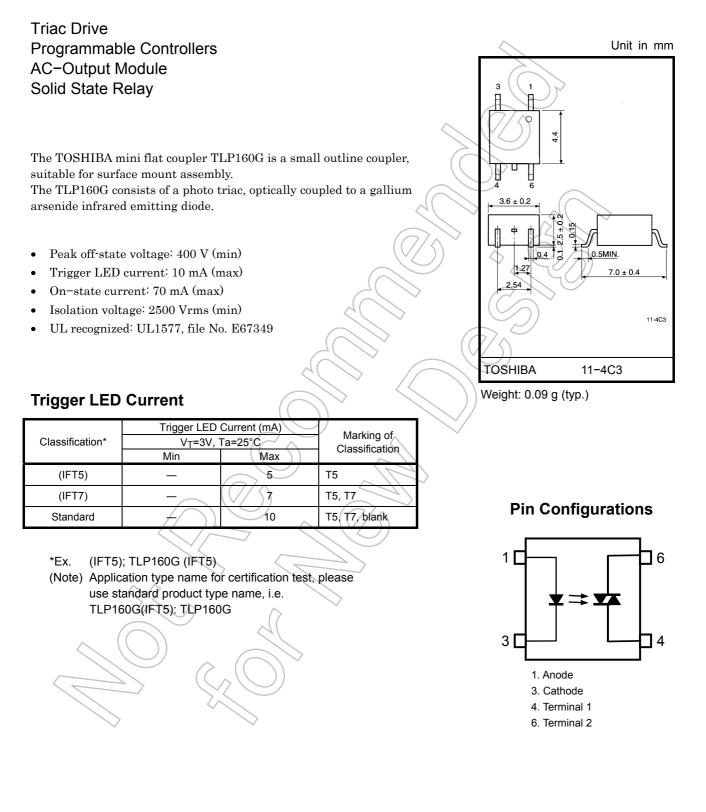
## TOSHIBA

TOSHIBA Photocoupler GaAs Ired & Photo-Triac

# TLP160G



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit		
LED	Forward current		١ <sub>F</sub>	50	mA	
	Forward current derating (Ta ≥ 53°C)		ΔI <sub>F</sub> / °C	-0.7	mA / °C	
	Peak forward current (100µs pulse, 100 pps)		I <sub>FP</sub>	1	A	
	Reverse voltage		V <sub>R</sub>	5	V	
	Junction temperature		Tj	125	°C	$\mathcal{Y}$
	Off- state output terminal voltage		V <sub>DRM</sub>	400		
	On-state RMS current	Ta=25°C	I <sub>T(RMS)</sub>	70	mA	)
Detector		Ta=70°C		40		
	On–state current derating (Ta ≥ 25°C)		ΔI <sub>T</sub> / °C	-0.67	mA / °C	
Det	Peak on-state current (100µs pulse, 120 pps)		I <sub>TP</sub>	2	A	
	Peak non-repetitive surge current (P <sub>W</sub> =10ms)		ITSM	1.2	A	
	Junction temperature		Tj	115	ŝ	$(\bigcirc)$
Storage temperature range		T <sub>stg</sub>	-55 to 125	°c <		
Operating temperature range		Topr	-40 to 100	°C		
Lead soldering temperature (10s)		T <sub>sol</sub>	260	°C	))	
Isolation voltage (AC, 1 minute, R.H. $\leq$ 60%) (Note)			BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	-	120	Vac
Forward current	IF	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	_	—	1	А
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

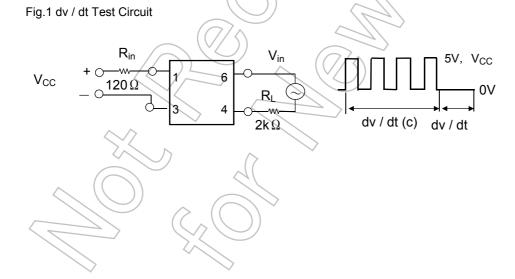
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### Individual Electrical Characteristics (Ta = 25°C)

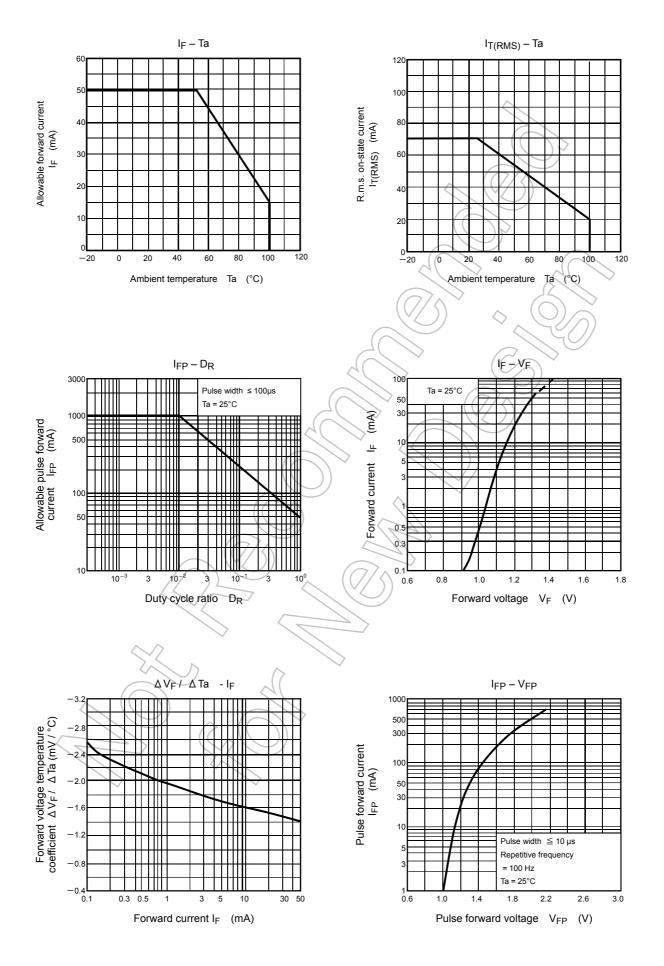
	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5V	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	X	30	_	pF
Detector	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> = 400 V		10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 70 mA	K	) 1.7	2.8	V
	Holding current	Ι <sub>Η</sub>	6	$\sum_{i=1}^{n}$	0.6	—	mA
	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 120 Vrms, Ta = 85 °C (Fig.1)	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	I <sub>T</sub> = 15 mA, V <sub>in</sub> = 30 Vrms (Fig.1)	> _	0.2	—	V / µs

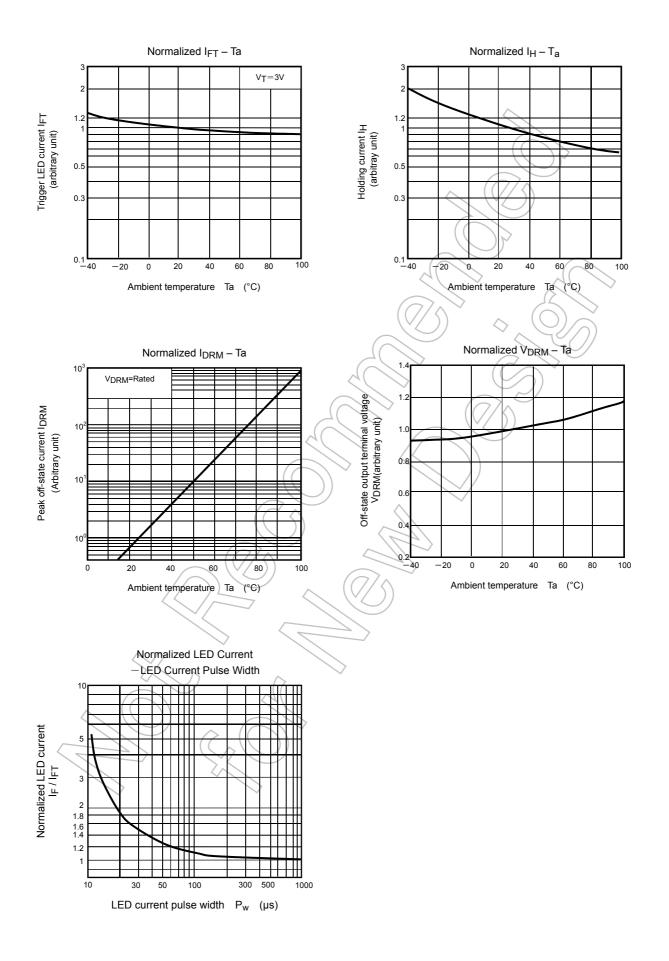
## Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min.	Тур	Max.	Unit
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> = 3V	$\sim$	5	10	mA
Capacitance input to output	Cs	V <sub>S</sub> = 0, f = 1 MHz	$\mathcal{C}_{\mathcal{A}}$	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500V, R.H. ≤ 60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
	BVS	AC, 1 minute	2500	—	_	) (mag
Isolation voltage		AC, 1 second, in oil	2 –	5000	_	Vrms
		DC, 1 minute, in oil	—	5000	_	Vdc
Turn–on time	ton	$V_D = 6 \rightarrow 4 V, R_L = 100\Omega$ I <sub>F</sub> =rate I <sub>FT</sub> ×1.5	_	30	100	μs



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